

3. (Amended) A magnetic [recording] head according to claim [2] 1, wherein said recording track layer comprises at least one of a read track and a write track.

4. (Amended) A magnetic [recording] head according to claim 3, wherein at least one of said gluing vias are trenched on said side surface of said substrate between said at least one of a read track and a write track.

5. (Amended) A magnetic [recording] head according to claim 1 wherein said gluing vias are photolithographically defined and subsequently trenched on said side surfaces.

6. (Amended) A magnetic tape head for reading from and writing to a magnetic tape moving across the head, comprising:

a substrate having a gap side surface;

a closure having a gap side surface that opposes and is separated from said gap side surface of said substrate by a gap;

a thin film layer deposited on said gap side surface of said substrate in said gap, wherein said thin film layer comprises a recording track layer and has a nonplanar topography along said gap;

[one or more] a plurality of gluing vias [on either or both of] formed between said substrate and said closure; and

adhesive in said gap and said gluing vias.

Cancel Claim 7 without prejudice or disclaimer.

8. (Amended) A magnetic tape head according to claim [7] 6, wherein said recording track layer comprises at least one of a read track and a write track.

9. (Amended) A magnetic tape head according to claim 8 wherein at least one of said gluing vias are trenched on said side surface of said substrate between said at least one of a read track and a write track.

10. (Amended) A magnetic [recording] tape head according to claim 6 wherein said gluing vias are photolithographically defined and subsequently trenched on [one or both] at least one of said gap side surfaces of said substrate and said closure.

11. (Amended) A method of manufacturing a multi-track tape head for at least one of reading from and writing to a medium, comprising the steps of:

depositing a recording track layer on a substrate;

forming a C-core in a closure;

trenching gluing vias on a gap side surface of [either or both] at least one of said substrate

and [a] said closure; and

bonding said substrate and said closure together by introducing adhesive into said C-core and said gluing vias.

12. A method according to claim 11, wherein said step of forming said recording track comprises forming at least one of a read track and a write track on said substrate.

13. A method according to claim 11, wherein said step of trenching includes the step of photolithographically defining said gluing vias.

14. (Amended) A method according to claim 11 [further including] wherein the step of forming a C-core includes the step of [machining a] forming said C-core on said gap side surface of said closure.

Cancel Claim 15 without prejudice or disclaimer.

16. (Amended) [A method according to claim 11] A method of manufacturing a multi-track tape head for at least one of reading from and writing to a medium, comprising the steps of:

depositing a recording track layer on a substrate;

forming gluing vias on a gap side surface of at least one of said substrate and a closure,

wherein at least one of said gluing vias are trenched on said side surface of said substrate between a read track and a write track on said recording track layer; and

bonding said substrate and said closure together by introducing adhesive into said gluing

vias.

Add Claim 17. The method of Claim 16 further comprising the step of forming a C-core on said gap side surface of said closure.

Sub E17
comd.
Add Claim 18. The method of Claim 17 wherein said step of bonding includes the step of introducing said adhesive into said C-core.

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comd.
Sub E1
~~Add Claim 19. The magnetic head of Claim 1 formed in accordance with the method of Claim 11.~~

Add Claim 20. The magnetic head of Claim 1 wherein at least a portion of said plurality of gluing vias intersects said C-core.

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Date: May 12, 1999

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